# **Dual 4-Stage Binary Counter**

The SN74LS393 contains a pair of high-speed 4-stage ripple counters.

Each half of the LS393 operates as a Modulo-16 binary divider, with the last three stages triggered in a ripple fashion. In the LS393, the flip-flops are triggered by a HIGH-to-LOW transition of their CP inputs. Each half of each circuit type has a Master Reset input which responds to a HIGH signal by forcing all four outputs to the LOW state.

- Dual Versions
- Individual Asynchronous Clear for Each Counter
- Typical Max Count Frequency of 50 MHz
- Input Clamp Diodes Minimize High Speed Termination Effects

## **GUARANTEED OPERATING RANGES**

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	4.75	5.0	5.25	V
T <sub>A</sub>	Operating Ambient Temperature Range	0	25	70	°C
I <sub>OH</sub>	Output Current – High			-0.4	mA
I <sub>OL</sub>	Output Current – Low			8.0	mA



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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 646



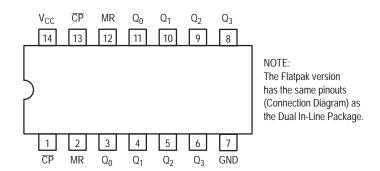
SOIC D SUFFIX CASE 751A

#### **ORDERING INFORMATION**

Device	Package	Shipping
SN74LS393N	14 Pin DIP	2000 Units/Box
SN74LS393D	14 Pin	2500/Tape & Reel

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# CONNECTION DIAGRAM DIP (TOP VIEW)



		LOADING	(Note a)
PIN NAMES	3	HIGH	LOW
CP	Clock (Active LOW Going Edge)		
	Input to +16 (LS393)	0.5 U.L.	1.0 U.L.
$\overline{CP}_0$	Clock (Active LOW Going Edge)		
	Input to ÷2 (LS390)	0.5 U.L.	1.0 U.L.
CP₁	Clock (Active LOW Going Edge)		
	Input to ÷ 5 (LS390)	0.5 U.L.	1.5 U.L.
MR	Master Reset (Active HIGH) Input	0.5 U.L.	0.25 U.L.
$Q_0 - Q_3$	Flip–Flop Outputs	10 U.L.	5 U.L.

## NOTES:

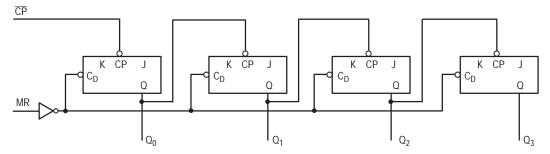
a) 1 TTL Unit Load (U.L.) = 40  $\mu$ A HIGH/1.6 mA LOW.

## **FUNCTIONAL DESCRIPTION**

Each half of the SN74LS393 operates in the Modulo 16 binary sequence, as indicated in the  $\div 16$  Truth Table. The first flip-flop is triggered by HIGH-to-LOW transitions of the CP input signal. Each of the other flip-flops is triggered by a HIGH-to-LOW transition of the Q output of the preceding flip-flop. Thus state changes of the Q outputs do

not occur simultaneously. This means that logic signals derived from combinations of these outputs will be subject to decoding spikes and, therefore, should not be used as clocks for other counters, registers or flip-flops. A HIGH signal on MR forces all outputs to the LOW state and prevents counting.

## SN74LS393 LOGIC DIAGRAM (one half shown)



TRUTH TABLE

COUNT		OUTPUTS					
COUNT	$Q_3$	$Q_2$	Q <sub>1</sub>	$Q_0$			
0 1 2 3				L H L	•		
4 5 6 7		H H H	LHH	L H L			
8 9 10 11	HHHH			L H L			
12 13 14 15	<b>H H H H</b>	<b>1111</b>		L H L H			

H = HIGH Voltage Level L = LOW Voltage Level

# DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits					
Symbol	Parameter		Min	Тур	Max	Unit	<b>Test Conditions</b>	
V <sub>IH</sub>	Input HIGH Voltage		2.0			V	Guaranteed Inpu All Inputs	t HIGH Voltage for
V <sub>IL</sub>	Input LOW Voltage	Input LOW Voltage			0.8	V	Guaranteed Inpu All Inputs	t LOW Voltage for
V <sub>IK</sub>	Input Clamp Diode Vol	tage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} =$	–18 mA
V <sub>OH</sub>	Output HIGH Voltage		2.7	3.5		V	$V_{CC}$ = MIN, $I_{OH}$ = MAX, $V_{IN}$ = $V_{IH}$ or $V_{IL}$ per Truth Table	
M	Output LOW Voltage			0.25	0.4	V	I <sub>OL</sub> = 4.0 mA	$V_{CC} = V_{CC} MIN,$ $V_{IN} = V_{IL} \text{ or } V_{IH}$
V <sub>OL</sub>				0.35	0.5	V	I <sub>OL</sub> = 8.0 mA	per Truth Table
	Innut I II CI I Cumant				20	μΑ	$V_{CC} = MAX, V_{IN}$	= 2.7 V
l <sub>IH</sub>	Input HIGH Current				0.1	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub>	= 7.0 V
		MR			-0.4	mA		
I <sub>IL</sub>	$I_{IL}$ Input LOW Current $\overline{CP, CP_0}$ $\overline{CP_1}$				-1.6	mA	$V_{CC} = MAX, V_{IN} = 0.4 V$	
					-2.4	mA		
I <sub>OS</sub>	Short Circuit Current (1	Note 1)	-20		-100	mA	V <sub>CC</sub> = MAX	
I <sub>CC</sub>	Power Supply Current	·			26	mA	V <sub>CC</sub> = MAX	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

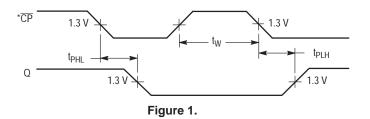
# AC CHARACTERISTICS ( $T_A = 25^{\circ}C$ , $V_{CC} = 5.0 \text{ V}$ )

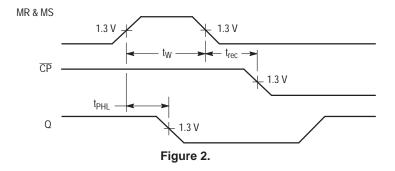
			Limits			
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
f <sub>MAX</sub>	Maximum Clock Frequency $\overline{CP}_0$ to $Q_0$	25	35		MHz	
f <sub>MAX</sub>	Maximum Clock Frequency  CP <sub>1</sub> to Q <sub>1</sub>	20			MHz	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay,  CP to Q <sub>0</sub>		12 13	20 20	ns	C <sub>L</sub> = 15 pF
t <sub>PLH</sub> t <sub>PHL</sub>	CP to Q₃		40 40	60 60	ns	
t <sub>PHL</sub>	MR to Any Output		24	39	ns	

# AC SETUP REQUIREMENTS (TA = $25^{\circ}$ C, V<sub>CC</sub> = 5.0 V)

		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t <sub>W</sub>	Clock Pulse Width	20			ns	
t <sub>W</sub>	MR Pulse Width	20			ns	V <sub>CC</sub> = 5.0 V
t <sub>rec</sub>	Recovery Time	25			ns	

# AC WAVEFORMS

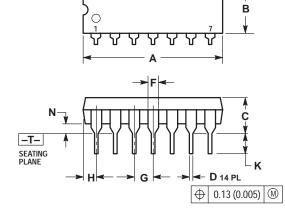


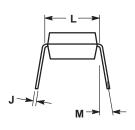


 $^{\star}$ The number of Clock Pulses required between  $t_{PHL}$  and  $t_{PLH}$  measurements can be determined from the appropriate Truth Table.

# **PACKAGE DIMENSIONS**

## **N SUFFIX** PLASTIC PACKAGE CASE 646-06 ISSUE M



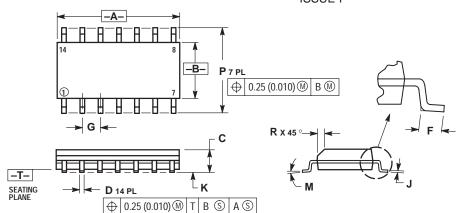


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MIN MAX		MAX	
Α	0.715	0.770	18.16	18.80	
В	0.240	0.260	6.10	6.60	
С	0.145	0.185	3.69	4.69	
D	0.015	0.021	0.38	0.53	
F	0.040	0.070	1.02	1.78	
G	0.100	BSC	2.54 BSC		
Н	0.052	0.095	1.32	2.41	
J	0.008	0.015	0.20	0.38	
K	0.115	0.135	2.92	3.43	
L	0.290	0.310	7.37	7.87	
M		10°		10°	
N	0.015	U U30	0.20	1.01	

# **PACKAGE DIMENSIONS**

## **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751A-03 ISSUE F



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.55	8.75	0.337	0.344
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7°	0 °	7°
Р	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

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